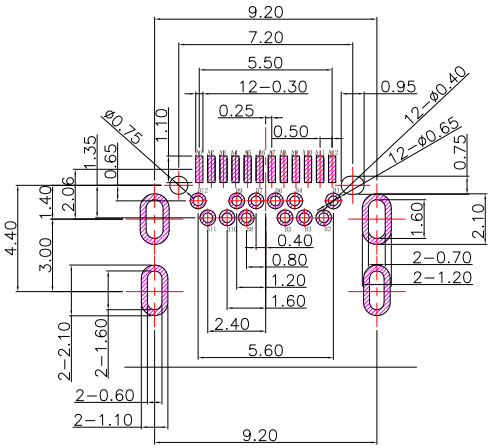
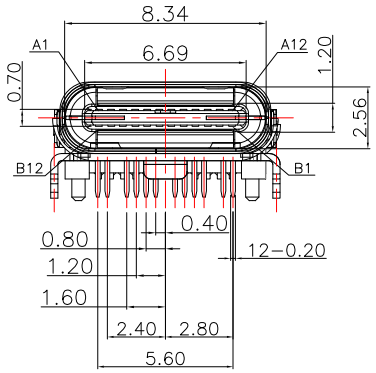


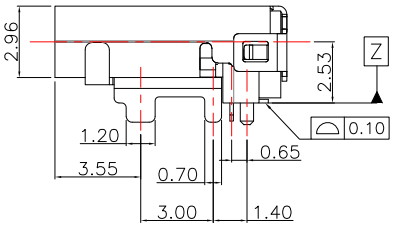
SBC-240S9-31x-S242

鍍層厚度 :

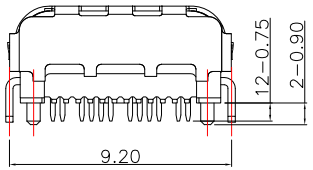
Blank : 1u"
2 : 15u"
3 : 30u"

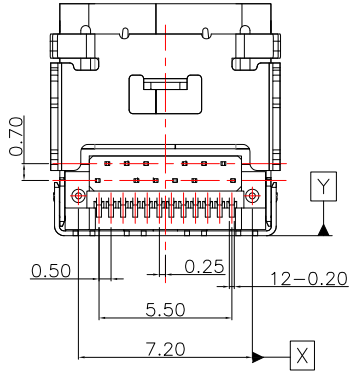






P.C.B LAYOUT MOUNTING PATTERN





PIN	SIGNAL NAME	PIN	SIGNAL NAME
A1	GND	B12	GND
A2	TX1+	B11	RX1+
A3	TX1−	B10	RX1−
A4	VBUS	B9	VBUS
A5	CC1	B8	SBU2
A6	D+	B7	D−
A7	D−	B6	D+
A8	SBU1	B5	CC2
A9	VBUS	B4	VBUS
A10	RX2−	B3	TX2−
A11	RX2+	B2	TX2+
A12	GND	B1	GND

SPECIFICATIONS

Electrical:

1.Current Rating: 3.0A For VBUS Pin
1.25A For VCONN Pin

2.Contact Resistance: 40 mΩ Max

3.Insulation Resistance: 100 MΩ Min

4.Dielectric Withstanding Voltage: 100V AC

Mechanical:

1.Connector Mate and Unmate Force

1.1 Mate force: 5~20 N

1.2 Unmate force: 6~20 N

Material:

1.Housing:LCP

2.Contact:Copper Alloy

3.Shell: Stainless Steel

Finish:

1.Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall

2.Shell: Nickel under Plated surface layer

ITEM NO.	DESCRIPTION	DRAWN	DATE
3	更新MODLE	Jack	081720
2	新增PCB LAYOUT尺寸	Jack	031920
1	更新圖面	Jack	010418

CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED : Up to 5 ±0.2; Above 5 ~ 15 ±0.3; Above 15 ~ 30 ±0.4; Above 30 ~ 50 ±0.5; Angle ±0.3°

3RD. ANGEL'S | UNITS MM

DRAWN BY: Jack Lu	DATE 08/17/20	MAT'L	
CHECKED BY: Jacky Chen	DATE 08/17/20	FINISH	
APPROVED BY: Tony Kao	DATE 08/17/20	SCALE 1 : 1	SHEET NO. 1 of 1

TITLE	CONNECTOR		
MODLE	USB 3.1 TYPE C 母座板上 L:9.6 排距0.7 加高型 H:4.01mm GEN 2/10G		
DWG NO.	SBC-240S9-31x-S242	SIZE	A4
PART NO.	SBC-240S9-31x-S242	VER	R3